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MB39A134

DC/DC Converter IC for Charging Li-ion Battery

Description

The MB39A134 is a DC/DC converter IC for charging Li-ion battery, which is suitable for down conversion, and uses pulse width modulation (PWM) for controlling the charge voltage and current independently.
MB39A134 has a AC adapter detection comparator independent of the DC/DC converter controller, and can control the source of power supply to a system. It supports a wide input voltage range, enables low current consumption in standby mode, and can control the charge voltage and charge current with high precision, which is perfect for the built-in Li-ion battery charger used in devices such as notebook PC.

Features

- Support 2, 3 and 4 Cell Battery Pack
- Built-in two constant current control loops
- Built-in AC adapter detection function (ACOK pin)
- Charge voltage accuracy : ±0.7% (Ta = −10° C to +85°C)
- Built-in charging voltage control without external setting resistor (4.20 V/Cell or 4.10 V/Cell)
  Adjustable to charge voltage with external resistor
- Built-in two high accurate current detection amplifiers (±1%) (At input voltage difference 100 mV)
  (±5%) (At input voltage difference 20 mV)
  Input offset voltage: 0 mV (Current Amp1)
  : +3 mV (Current Amp2)
- Built-in Charging Current Control without external resistor (R_S = 20 mΩ : 2.85 A)
  Adjustable charging current with external resistor
- Setting of switching frequency using an external resistor
  (Frequency setting capacitor integrated) : 100 kHz to 2 MHz
- Built-in under voltage lockout protection
- In standby mode (I_{CC} = 6 µA Typ) , only AC adapter detection function is operated
- Built-in VH regulator for reducing Qg loss of P-ch MOS FET
- Package : TSSOP-24

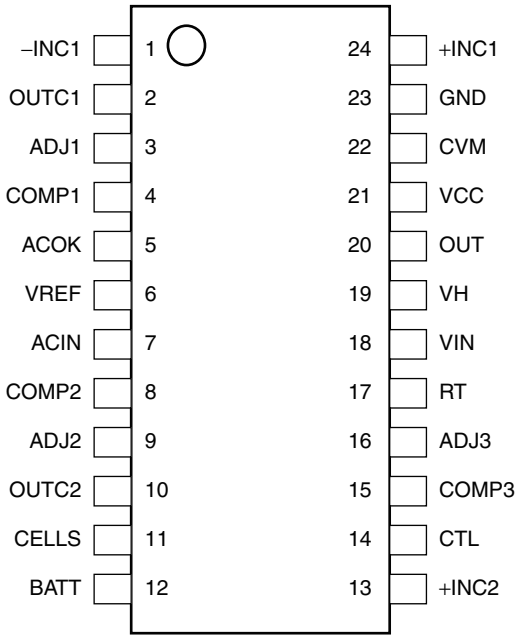
Applications

- Built-in charger for Notebook PC
- Handy terminal device etc.

Contents

1. Pin Assignment

(TOP VIEW)

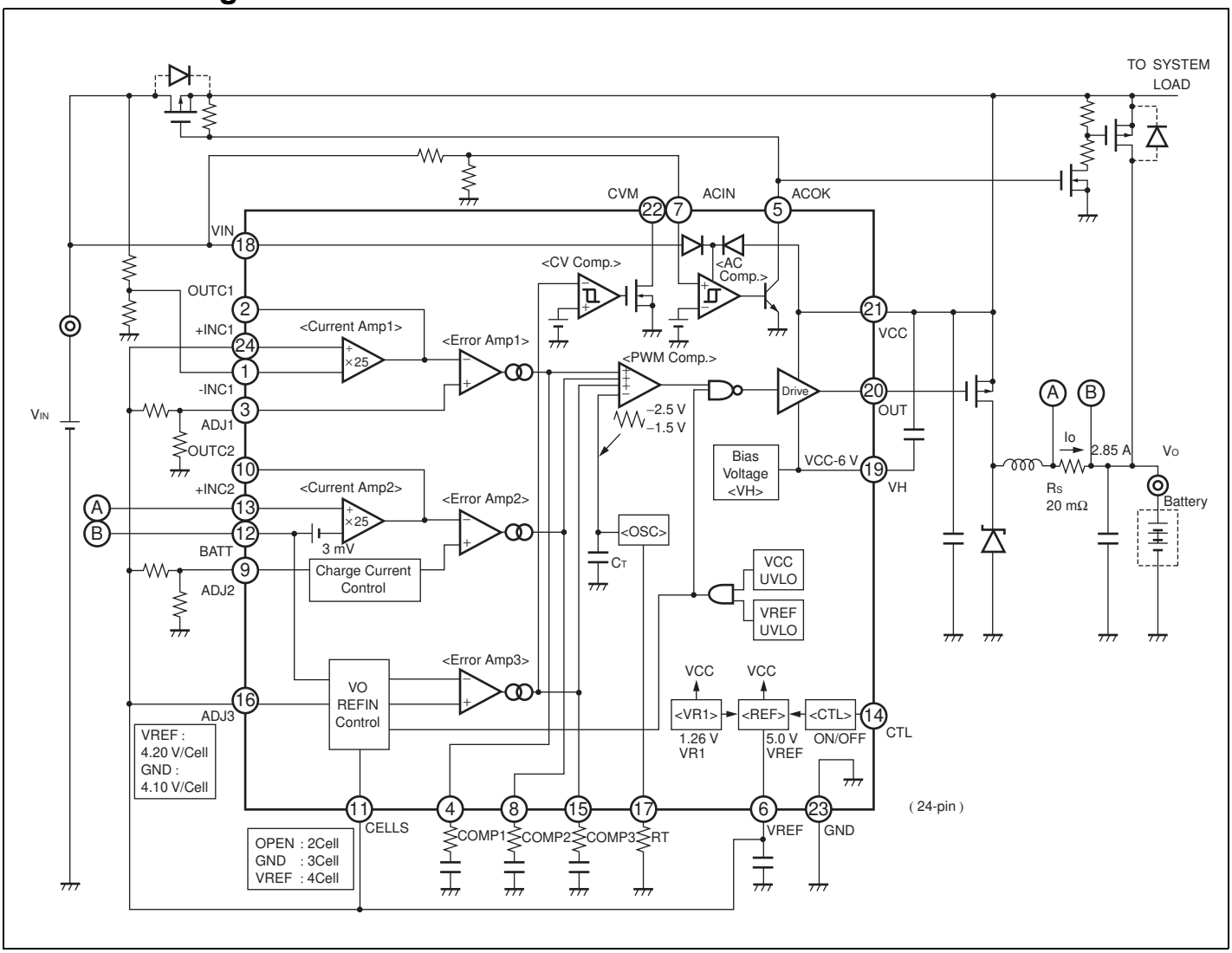


(STF024)

2. Pin Descriptions

Pin No.	Pin Name	I/O	Description
1	-INC1	I	Current detection amplifier (Current Amp1) inverted input pin.
2	OUTC1	O	Current detection amplifier (Current Amp1) output pin.
3	ADJ1	I	Error amplifier (Error Amp1) non-inverted input pin.
4	COMP1	O	Error amplifier (Error Amp1) output pin.
5	ACOK	O	AC adapter voltage detection block (AC Comp.) output pin. ACIN = H : ACOK = L, ACIN = L : ACOK = Hi-Z
6	VREF	O	Reference voltage output pin.
7	ACIN	I	AC adapter voltage detection block (AC Comp.) input pin.
8	COMP2	O	Error amplifier (Error Amp2) output pin.
9	ADJ2	I	Charge current control block setting input pin. ADJ2 pin “GND to 4.4 V” : Charge current control block output = ADJ2 pin voltage ADJ2 pin “4.6 V to VREF” : Charge current control block output = 1.5 V
10	OUTC2	O	Current detection amplifier (Current Amp2) output pin.
11	CELLS	I	Charge voltage setting switch pin (2 or 3 or 4 Cells). CELLS = VREF: 4 Cells, CELLS = GND: 3 Cells, CELLS = OPEN: 2 Cells
12	BATT	I	Current detection amplifier (Current Amp2) inverted input pin. Battery voltage input pin.
13	+INC2	I	Current detection amplifier (Current Amp2) non-inverted input pin.
14	CTL	I	Power supply control pin. Setting the CTL pin at “H” level places the DC/DC converter IC in the operating mode. Setting the CTL pin at “L” level places the DC/DC converter IC in the standby mode.
15	COMP3	O	Error amplifier (Error Amp3) output pin.
16	ADJ3	I	Charge voltage control block setting input pin. ADJ3 pin “GND to 0.2 V” : Charge voltage setting 4.10 V/Cell ADJ3 pin “0.4 V to 4.4 V” : Charge voltage setting 2 × V_{ADJ3} pin voltage/Cell ADJ3 pin “4.6 V to VREF” : Charge voltage setting 4.20 V/Cell
17	RT	–	Triangular wAVe oscillation frequency setting resistor connection pin.
18	VIN	–	Power supply pin for ACOK function block.
19	VH	O	Power supply pin for FET drive circuit (VH = VCC – 6 V)
20	OUT	O	External FET gate drive pin.
21	VCC	–	Power supply pin for reference voltage , control circuit, and output circuit.
22	CVM	O	Constant voltage control state detection block (CV Comp.) output pin.
23	GND	–	Ground pin.
24	+INC1	I	Current detection amplifier (Current Amp1) non-inverted input pin.

3. Block Diagram



4. Absolute Maximum Ratings

Parameter	Symbol	Condition	Rating		Unit
			Min	Max	
Power supply voltage	V_{CC}	VCC, VIN pin	− 0.3	+ 28	V
		VCC, VIN pin, t ≤ 10 µs	− 0.3	+ 32	V
Output current	I_{OUT}	OUT pin	− 60	+ 60	mA
		OUT pin Duty ≤ 5% (t = 1/fosc × Duty)	− 700	+ 700	mA
CLT pin input voltage	V_{CTL}	CTL pin	− 0.3	+ 28	V
Input voltage	V_{INE}	ADJ1, ADJ2, ADJ3, CELLS, ACIN pin	− 0.3	V_{VREF} + 0.3	V
	V_{INC}	-INC1, +INC1, BATT, +INC2 pin	− 0.3	+ 28	V
Power dissipation	P_D	Ta ≤ + 25°	−	1282*1,*2	mW
		Ta = + 85°	−	512*1,*2	mW
Storage temperature	T_{STG}	−	− 55	+ 125	°C

*1 : See the diagram of “Typical Characteristics. Maximum Power Dissipation vs. Operating Ambient Temperature”, for the package power dissipation of Ta from + 25° C to + 85° C.

*2 : When IC is mounted on a 10x10 cm two-layer square epoxy board.

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

5. Recommended Operating Conditions

Parameter	Symbol	Condition	Value			Unit
			Min	Typ	Max	
Power supply voltage	V_{VCC}	VCC, VIN pin	8	—	25	V
Reference voltage output current	I_{VREF}	—	−1	—	0	mA
VH pin output current	I_{VH}	—	0	—	30	mA
Input voltage	V_{INE}	ADJ1 pin	0	—	V_{VREF} − 1.5	V
		ADJ2 pin (internal reference voltage setting)	4.6	—	V_{VREF}	V
		ADJ2 pin (external voltage setting)	0	—	4.4	V
		ADJ3 pin (internal reference voltage setting)	0	—	0.2	V
			4.6		V_{VREF}	V
		ADJ3 pin (external voltage setting)	0.4	—	4.4	V
		CELLS pin	0	—	V_{VREF}	V
	V_{INC}	+INC1, +INC2, -INC1, BATT pin	0	—	V_{VCC}	V
ACIN pin input voltage	V_{ACIN}	—	0	—	5	V
ACOK pin output voltage	V_{ACOK}	—	0	—	25	V
ACOK pin output current	I_{ACOK}	—	0	—	1	mA
CTL pin input voltage	V_{CTL}	—	0	—	25	V
Output current	I_{OUT}	OUT pin	−45	—	+ 45	mA
		OUT pin Duty ≤ 5% (t = 1 / fosc × Duty)	−600	—	+ 600	mA
Switching frequency	f_{OSC}	—	100	500	2000	kHz
Timing resistor	R_{RT}	RT pin	8.2	33	180	kΩ
VH pin capacitor	C_{VH}	—	—	0.1	1.0	µF
Reference voltage output capacitor	C_{VREF}	VREF pin	—	0.1	1.0	µF
Operating ambient temperature	Ta	—	−30	+ 25	+ 85	°C

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their representatives beforehand.

6. Electrical Characteristics

(Ta = +25°, VCC pin = 19 V, VREF pin = 0 mA)

Parameter		Symbol	Pin No.	Condition	Value			Unit
					Min	Typ	Max	
Reference Voltage Block [REF]	Threshold voltage	V_{VREF1}	6	–	4.963	5.000	5.037	V
		V_{VREF2}	6	Ta = −10° to +85°	4.950	5.000	5.050	V
	Input stability	VREF Line	6	VCC pin = 8 V to 25 V	–	3	10	mV
	Load stability	VREF Load	6	VREF pin = 0 mA to −1 mA	–	1	10	mV
	Short-circuit output current	Ios	6	VREF pin = 1 V	−25	−12	−6	mA
Triangular Wave Oscillator Block [OSC]	Switching frequency	f_{OSC}	20	RT pin = 33 kΩ	450	500	550	kHz
	Frequency temperature variation	df/fdT	20	Ta = −30° to +85°	–	1*	–	%
Error Amplifier Block [Error Amp1]	Input offset voltage	V_{IO}	2, 3	COMP1 pin = 2 V	–	1	5	mV
	Input bias voltage	I_{ADJ1}	3	ADJ1 pin = 0 V	−100	–	–	nA
	Transconduc-tance	Gm	15	–	–	20*	–	µA/V
Error Amplifier Block [Error Amp2]	Threshold voltage	V_{TH1}	10	ADJ2 pin = VREF pin	–	1.5*	–	V
	Transconduc-tance	Gm	15	–	–	20*	–	µA/V
Error Amplifier Block [Error Amp3]	Threshold voltage accuracy	V_{TH1}	12	COMP3 pin = 2 V, Ta = +25° ADJ3 pin = VREF pin (4.20 V/Cell setting)	−0.5	0	+ 0.5	%
		V_{TH2}	12	COMP3 pin = 2 V, Ta = −10° to +85°, ADJ3 pin = VREF pin (4.20 V/Cell setting)	−0.7	0	+ 0.7	%
		V_{TH3}	12	COMP3 pin = 2 V, Ta = +25° ADJ3 pin = GND, (4.10 V/Cell setting)	−0.6	0	+ 0.6	%
		V_{TH4}	12	COMP3 pin = 2 V, Ta = − 10° to +85° ADJ3 pin = GND, (4.10 V/Cell setting)	−0.8	0	+ 0.8	%

(Ta = +25°, VCC pin = 19 V, VREF pin = 0 mA)

Parameter		Symbol	Pin No.	Condition	Value			Unit
					Min	Typ	Max	
Error Amplifier Block [Error Amp3]	Input current	I_{BATTH1}	12	ADJ3 pin = CELLS pin = VREF pin BATT pin = 16.8 V	–	25.2	38	µA
		I_{BATTL}	12	VCC pin = 0 V, BATT pin = 16.8 V	–	0	1	µA
	Transconduc-tance	Gm	15	–	–	30*	–	µA/V
Current Detection Amplifier Block [Current Amp1, Current Amp2]	Input current	I_{+INCH}	13, 24	+INC1 pin = +INC2 pin = 3 V to VCC pin, ΔVin = −100 mV	–	20	30	µA
		I_{-INCH}	1	+INC1 pin = 3 V to VCC pin, ΔVin = −100 mV	–	0.1	0.2	µA
		I_{+INCL}	13, 24	+INC1 pin = +INC2 pin = 0.1 V, ΔVin = −100 mV	−225	−150	–	µA
		I_{-INCL}	1	+INC1 pin = +INC2 pin = 0.1 V, ΔVin = −100 mV	−255	−170	–	µA
	Input offset voltage	V_{OFF1}	2	+INC1 pin = 3 V to VCC pin	−1	0	1	mV
		V_{OFF2}	10	+INC2 pin = 3 V to VCC pin	2	3	4	mV
		V_{OFF3}	10	+INC2 pin = 0 V to 3 V	1	3	5	mV
	Common mode input voltage range	V_{CM}	2, 10	–	0	–	Vvcc	V
	Voltage gain	A_V	2, 10	+INC1 pin = +INC2 pin = 3 V to VCC pin, ΔVin = −100 mV	24.5	25.0	25.5	V/V
	Frequency band width	BW	2, 10	A_V = 0 dB	–	2*	–	MHz
	Output voltage	V_{OUTCH1}	2	–	4.7	4.9	–	V
		V_{OUTCH2}	10	–	4.5	4.7	–	V
		V_{OUTCL}	2, 10	–	50	75	100	mV
	Output source current	I_{SOURCE}	2, 10	OUTC1 pin = OUTC2 pin = 2 V	–	−2	−1	mA
	Output sink current	I_{SINK}	2, 10	OUTC1 pin = OUTC2 pin = 2 V	150	300	–	µA
PWM Comp. Block [PWM Comp.]	Threshold voltage	V_{TL}	20	Duty cycle = 0%	1.4	1.5	–	V
		V_{TH}	20	Duty cycle = 100%	–	2.5	2.6	V

(Ta = +25°, VCC pin = 19 V, VREF pin = 0 mA)

Parameter		Symbol	Pin No.	Condition	Value			Unit
					Min.	Typ.	Max.	
Output Block [OUT]	Output source current	I_{SOURCE}	20	OUT pin = 13 V, Duty ≤ 5% (t = 1/fosc ∞ Duty)	–	–400*	–	mA
	Output sink current	I_{SINK}	20	OUT pin = 19V, Duty ≤ 5% (t = 1/fosc ∞ Duty)	–	400*	–	mA
	Output ON resistance	R_{OH}	20	OUT pin = –45 mA	–	6.5	9.8	Ω
		R_{OL}	20	OUT pin = 45 mA	–	5.0	7.5	Ω
	Rise time	tr1	20	OUT pin = 3300 pF	–	50*	–	ns
	Fall time	tf1	20	OUT pin = 3300 pF	–	50*	–	ns
Control Block [CTL]	CTL input voltage	V_{ON}	14	IC operation mode	2		25	V
		V_{OFF}	14	IC standby mode	0		0.8	V
	Input current	I_{CTLH}	14	CTL pin = 5 V	–	100	150	µA
		I_{CTLL}	14	CTL pin = 0 V	–	0	1	µA
Bias Voltage Block [VH]	Output voltage	V_H	19	VCC pin = 8 V to 25 V, VH pin = 0 to 30 mA	V_{VCC}– 6.5	V_{VCC}– 6.0	V_{VCC}– 5.5	V
Under Voltage Lockout Protection Circuit Block [UVLO]	Threshold voltage	V_{TLH}	21	VCC pin = ↑	6.0	6.2	6.4	V
		V_{THL}	21	VCC pin = ↓	5.0	5.2	5.4	V
	Hysteresis width	V_H	21	VCC pin	–	1.0*	–	V
	Threshold voltage	V_{TLH}	6	VREF pin = ↑	2.6	2.8	3.0	V
		V_{THL}	6	VREF pin = ↓	2.4	2.6	2.8	V
	Hysteresis width	V_H	6	VREF pin	–	0.2	–	V
Over Temperature Detection	Detection temperature	T_{TH}	20	–	–	+ 150	–	°C
	Release temperature	T_{TL}	20	–	–	+ 125	–	°C
AC Adapter Voltage Detection Block [AC Comp.]	Threshold voltage	V_{TLH}	7	–	1.245	1.270	1.295	V
		V_{THL}	7	–	1.215	1.250	1.285	V
	Hysteresis width	V_H	7	–	–	20	–	mV
	ACOK pin output leak current	I_{LEAK}	5	ACOK pin = 25 V	–	0	1	µA
	ACOK pin output “L” level voltage	V_{ACOKL}	5	ACOK pin = 1 mA	–	0.9	1.1	V
	Current consumption	I_{VINL}	18	VIN pin = 19 V, ACIN pin = 0 V	–	0	1	µA
		I_{VINH}	18	VIN pin = 19 V, ACIN pin = 5 V	–	6	10	µA

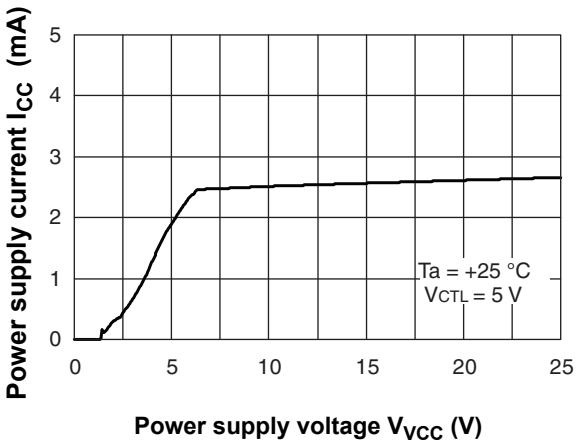
(Ta = +25°, VCC pin = 19 V, VREF pin = 0 mA)

Parameter		Symbol	Pin No.	Condition	Value			Unit
					Min.	Typ.	Max.	
Charge Voltage Control Block [VO REFIN Control]	Input voltage	V_H	16	At 4.20 V/Cell	4.6	–	V_{VREF}	V
		V_{EXT}	16	At external setting	0.4	–	4.4	V
		V_L	16	At 4.10 V/Cell	0	–	0.2	V
	Threshold voltage	V_{TL}	16	–	0.21	0.3	0.39	V
		V_{TH}	16	–	4.41	4.5	4.59	V
	Input current	I_{IN}	16	ADJ3 pin	–	0	1	µA
	Input voltage	V_H	11	At 4 Cells	V_{VREF} – 0.4	–	V_{VREF}	V
		V_M	11	At 2 Cells	2.4	–	2.6	V
		V_L	11	At 3 Cells	0	–	0.3	V
	Input current	I_{INL}	11	CELLS = 0 V	–8.3	–5	–	µA
		I_{INH}	11	CELLS = I_{VREF}	–	5	8.3	µA
Charge Current Control Block [Charge Current Control]	Input voltage	V_H	9	At normal charge	4.6	–	V_{VREF}	V
		V_{EXT}	9	At external setting	0	–	4.4	V
	Threshold voltage	V_{TH}	9	–	4.41	4.50	4.59	V
	Input current	I_{IN}	9	ADJ2 pin	–	0	1	µA
General	Standby current	I_{CCS1}	18	VCC pin = 0 V, CTL pin = 0 V, ACIN pin = 5 V, VIN pin = 19 V	–	6	10	µA
		I_{CCS2}	21	VIN pin = 0 V, CTL pin = 0 V, VCC pin = 19 V	–	0	1	µA
	Power supply current	I_{CC}	21	CTL pin = 5 V	–	2.7	4.0	mA

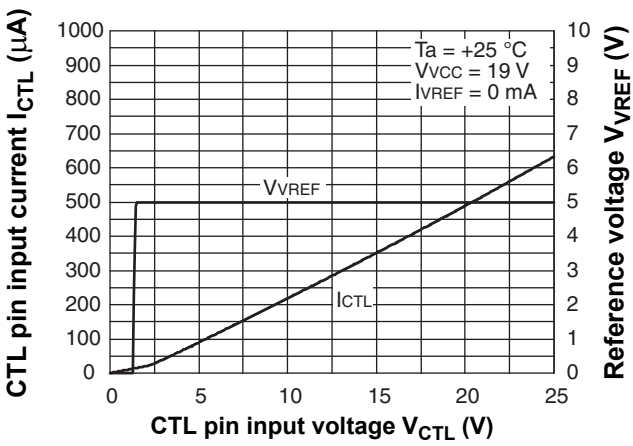
*: This parameter isn't be specified. This should be used as a reference to support designing the circuits.

7. Typical Characteristics

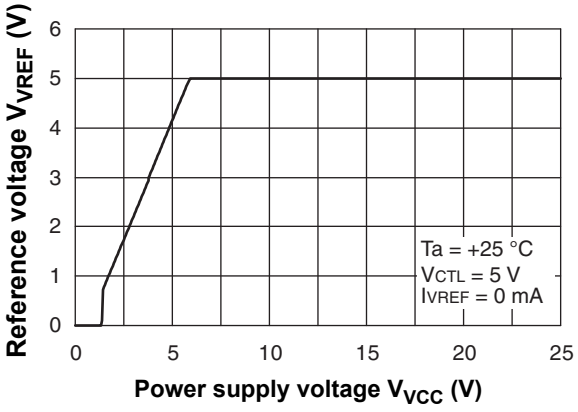
Power supply current vs. Power supply voltage



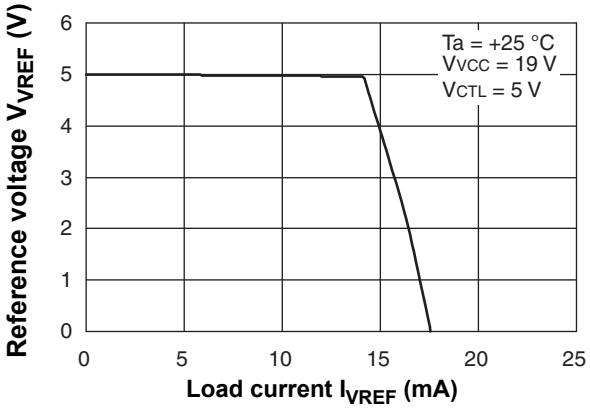
CTL pin input current, Reference voltage vs. CTL pin input voltage



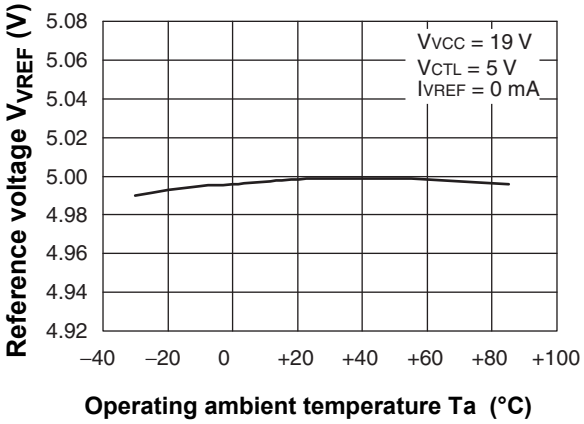
Reference voltage vs. Power supply voltage



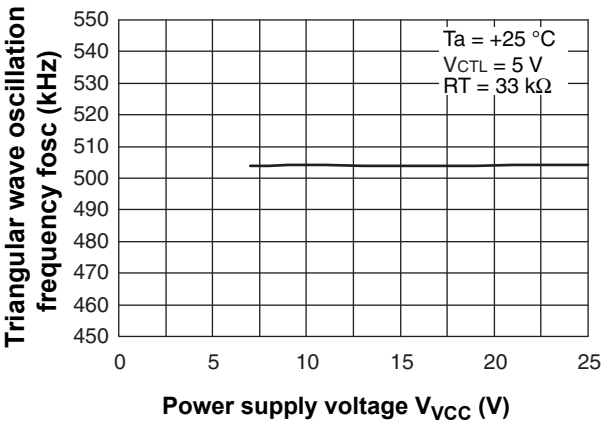
Reference voltage vs. Load current



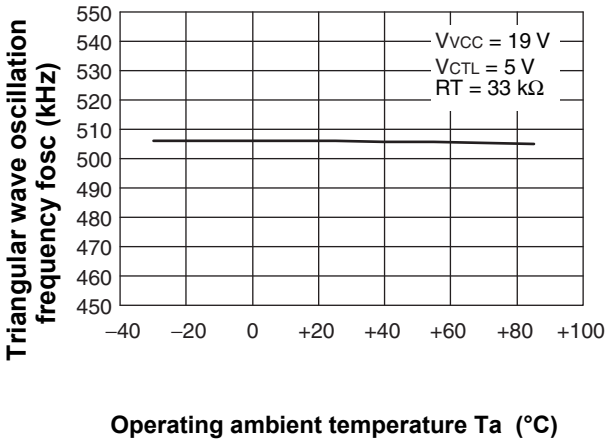
Reference voltage vs. Operating ambient temperature



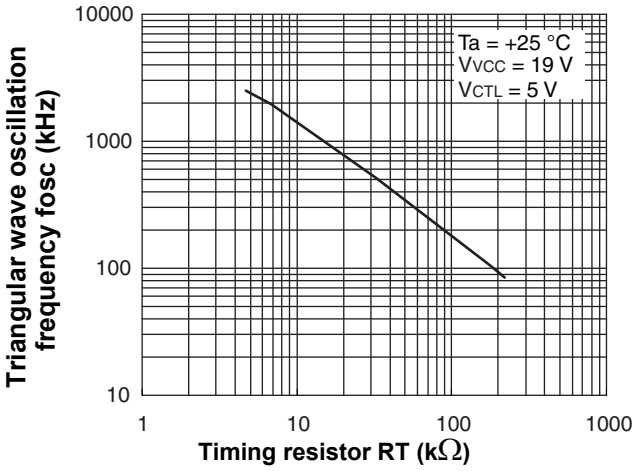
Triangular wave oscillation frequency vs. Power supply voltage



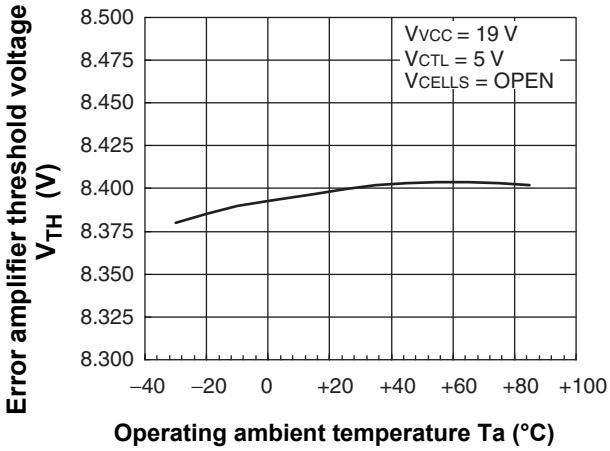
Triangular wave oscillation frequency vs. Operating ambient temperature



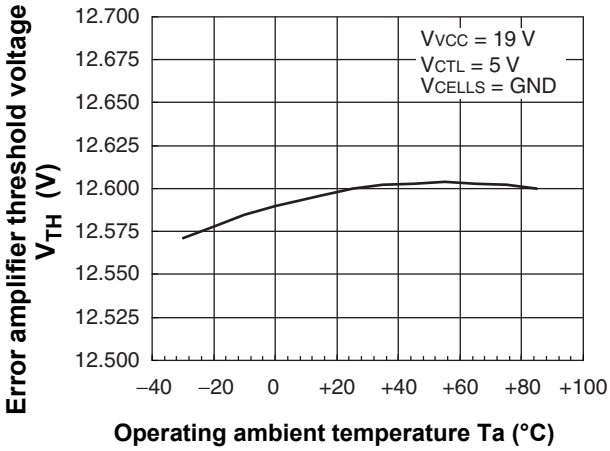
Triangular wave oscillation frequency vs. Timing resistor



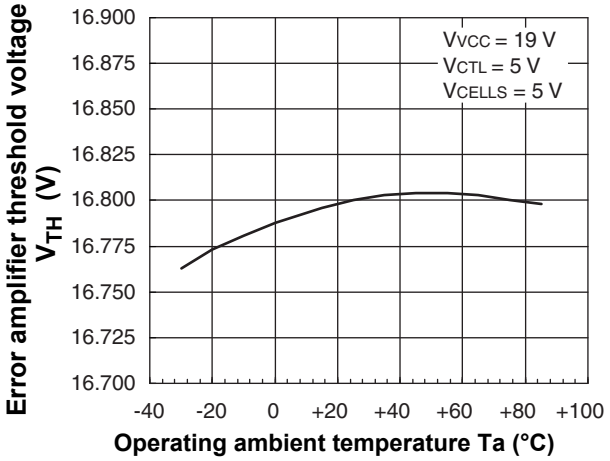
Error amplifier threshold voltage vs. Operating ambient temperature



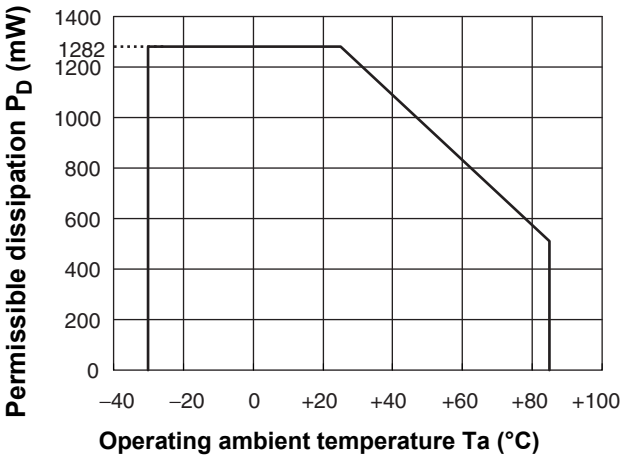
Error amplifier threshold voltage vs. Operating ambient temperature



Error amplifier threshold voltage vs. Operating ambient temperature



Permissible dissipation vs. Operating ambient temperature



8. Functional Description

MB39A134 is a DC/DC converter which uses pulse width modulation (PWM) for charging Li-ion battery and controls the charge voltage and current when charging the battery. It includes the charge control function for the battery and the AC adapter voltage detection function to stably supply the voltage from the AC adapter and the battery to the system.

- When controlling the charge voltage (constant voltage mode), the voltage entered in ADJ3 pin and CELLS pin can be used to set an arbitrary voltage. The error amplifier (Error Amp3) compares BATT pin voltage with the internal reference voltage to generate the PWM control signal for generating an arbitrary charge voltage.
- When controlling the charge current (constant current mode), the current detection amplifier (Current Amp2) amplifies the voltage drop generated between both ends of the charge current sense resistance (R_S) to 25 times and outputs it through OUTC2 pin. The error amplifier (Error Amp2) compares the output voltage from the current detection amplifier (Current Amp2) with the voltage set at ADJ2 pin to generate the PWM control signal for executing the constant current charge.
- When controlling the AC adapter power, the current detection amplifier (Current Amp1) amplifies the difference between -INC1 pin voltage and +INC1 pin voltage (V_{VREF}) to 25 times and outputs it through OUTC1 pin when the output voltage of the AC adapter drops. The error amplifier (Error Amp1) compares the output voltage from the current detection amplifier (Current Amp1) with ADJ1 pin voltage to generate the PWM control signal for controlling the charge current so that AC adapter power can be kept constant.

The triangular wave voltage generated from the triangular wave oscillator is compared with the lowest potential of the output voltages from the error amplifier (Error Amp1, Error Amp2, and Error Amp3) and when the former is lower than the latter, the high side switching FET is set on.

In addition, AC Comp detects installation/removal of the AC adapter and its information is generated through ACOK pin.

8.1 DC/DC Converter Block

8.1.1 Reference Voltage Block (REF)

The reference voltage circuit (REF) uses the voltage supplied from the VCC pin (pin 21) to generate stable voltage (Typ 5.0 V) that has undergone temperature compensation. The generated voltage is used as the reference power supply for the internal circuitry of the IC.
This block can output load current of up to 1 mA from the reference voltage VREF pin (pin 6).

8.1.2 Triangular Wave Oscillator Block (OSC)

The triangular wave oscillator builds the capacitor for frequency setting into, and generates the triangular wave oscillation waveform by connecting the frequency setting resistor with the RT pin (pin 17). The triangular wave is input to the PWM comparator on the IC.

Triangular wave oscillation frequency: fosc

fosc (kHz) ≈ 17000 / RT (kΩ)

8.1.3 Error Amplifier Block (Error Amp1)

This amplifier detects the output signal from the current detection amplifier (Current Amp1) and outputs a PWM control signal.
In addition, a stable phase compensation can be made available to the system by connecting the resistor and the capacitor to the COMP1 pin.

8.1.4 Error Amplifier Block (Error Amp2)

This amplifier detects the output signal from the current detection amplifier (Current Amp2), compares this to the output signal from the charge current control circuit, and outputs a PWM control signal to be used in controlling the charge current.
In addition, a stable phase compensation can be made available to the system by connecting the resistor and the capacitor to the COMP2 pin.

8.1.5 Error Amplifier Block (Error Amp3)

This error amplifier (Error Amp3) detects the output voltage from the DC/DC converter, compares this to the output signal from the VO REFIN controller circuit, and outputs the PWM control signal.
Arbitrary output voltage from 2 Cell to 4 Cell can be set by connecting an external resistor of charging voltage to ADJ3 pin (pin 16). In addition, a stable phase compensation can be made available to the system by connecting the resistor and the capacitor to the COMP3 pin.

8.1.6 Current Detection Amplifier Block (Current Amp1)

The current detection amplifier (Current Amp1) amplifies the voltage difference between +INC1 pin (pin 24) and -INC1 pin (pin 1) 25 times and the signal is output to the following error amplifier (Error Amp1) .

8.1.7 Current Detection Amplifier Block (Current Amp2)

The current detection amplifier (Current Amp2) detects a voltage drop on the both ends of the output sense resistor (R_S) due to the flow of the charge current, using the +INC2 pin (pin 13) and BATT pin (pin 12). The signal amplified to 25 times is output to the following error amplifier (Error Amp2).

8.1.8 PWM Comparator Block (PWM Comp.)

The PWM comparator circuit (PWM Comp.) is a voltage-pulse width converter for controlling the output duty of the error amplifiers (Error Amp1 to Error Amp3) depending on their output voltage.

The PWM comparator circuit compares the triangular wave voltage generated by the triangular wave oscillator with the error amplifier output voltage and turns on the external output transistor (MOS FET) , during the interval in which the triangular wave voltage is lower than the error amplifier output voltage.

8.1.9 Output Block (OUT)

The output circuit uses a totem-pole configuration capable of driving an external P-ch MOS FET.

The output “L” level sets the output amplitude to 6 V (Typ) using the voltage generated by the bias voltage block (VH) .

This results in increasing conversion efficiency and suppressing the withstand voltage of the connected external transistor (MOSFET) even in a wide range of input voltages.

8.1.10 Power Supply Control Block (CTL)

Setting the CTL pin (pin 14) to “L” level places the IC in the standby mode. During the standby mode, only AC adapter detection function is operated. (The supply current is 6 µA at typical in the standby mode.)

Table 1. CTL Function Table

CTL	Power	AC Adapter Detection
L	OFF (Standby)	ON (Active)
H	ON (Active)	ON (Active)

8.1.11 Bias Voltage Block (VH)

The bias voltage circuit outputs V_{VCC} − 6 V (Typ) as the minimum potential of the output circuit. In the standby mode, this circuit outputs the potential equal to V_{VCC}.

8.2 Protection Functions

8.2.1 Under Voltage Lockout Protection Circuit Block (UVLO)

The transient state or a momentary decrease in supply voltage or internal reference voltage (VREF pin), which occurs when the power supply (VCC pin) is turned on, may cause malfunctions in the control IC, resulting in breakdown or deterioration of the system.

To prevent such malfunction, the under voltage lockout protection circuit detects internal reference voltage drop and fixes the OUT pin (pin 20) to the “H” level. The system restores when the power supply and the internal reference reaches less than the threshold voltage of the lockout protection circuit at the low voltage level.

Protection circuit (UVLO) operation function table

When UVLO is operating (VCC or VREF voltage is lower than UVLO threshold voltage.), the logic of the following pin is fixed at the value shown.

pin	OUT
Status	H

8.2.2 Over Temperature Detection

The circuit protects an IC from heat-destruction. If the temperature at the joint part reaches +150°C, the circuit changes the level of OUT pin to “H”, and stops the voltage output.

In addition, if the temperature at the joint part drops to +125°C, the output restarts again.

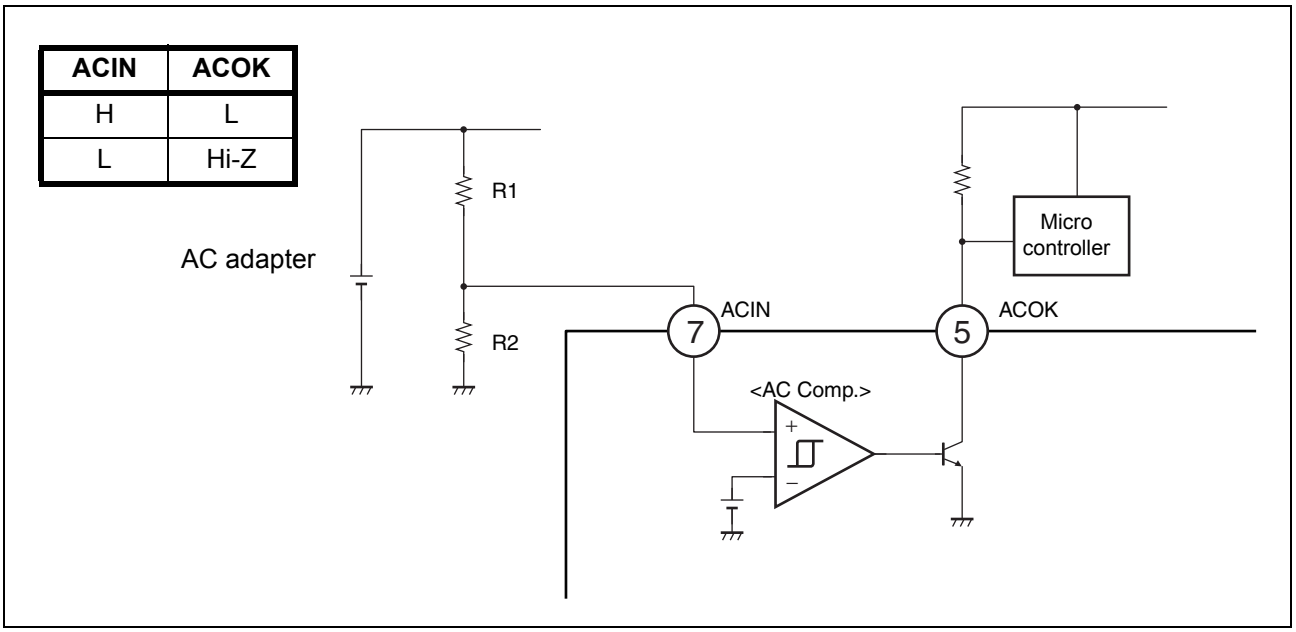
Therefore, make sure to design the DC/DC power supply system so that the over heating protection does not start frequently.

8.2.3 Detection Functions

AC adapter voltage detection block (AC Comp.)

The AC adapter voltage detection block (AC Comp.) detects that ACIN pin voltage is below 1.25 V (Typ) and sets ACOK pin in the AC adapter voltage detection block to Hi-Z. In addition, a higher voltage from either VCC pin or VIN pin is supplied as the IC power supply.

ACIN	ACOK
H	L
L	Hi-Z



AC adapter detection voltage setting

V_{IN} = Low to High

Vth = (R1 + R2) / R2 × 1.27 V

V_{IN} = High to Low

Vth = (R1 + R2) / R2 × 1.25 V

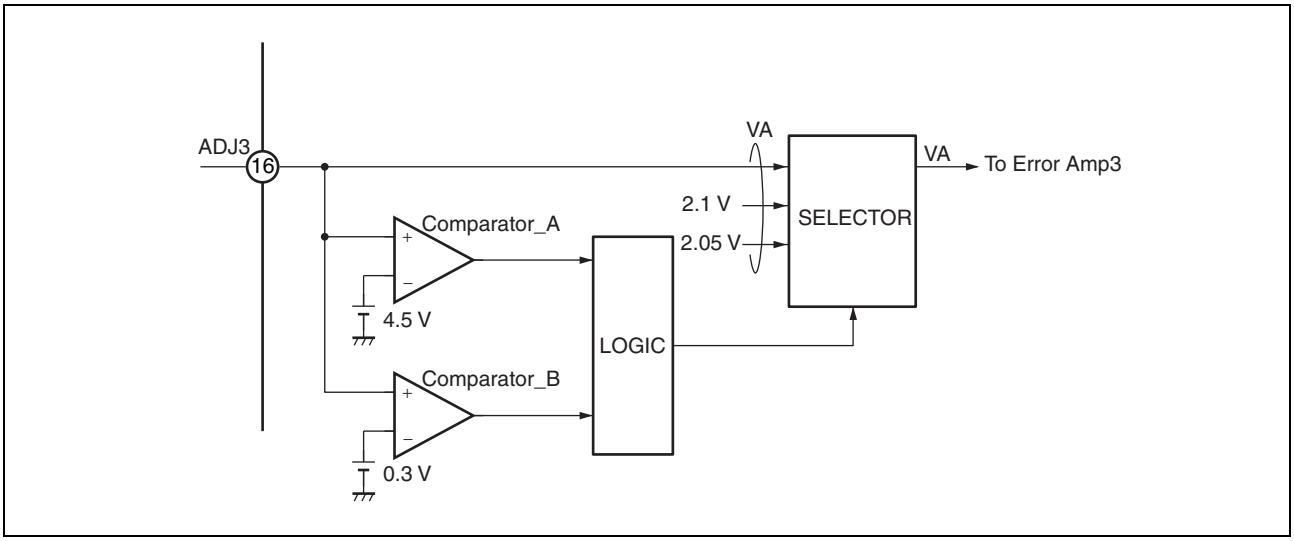
8.2.4 Setting the Charge Voltage

The charge voltage (DC/DC output) is set by the input voltage to ADJ3 pin (pin 16) and CELLS pin (pin 11). The ADJ3 pin (pin 16) can set charge voltage per cell. An arbitrary charge voltage is set when external resistor is set. It does not need external resistor when ADJ3 pin (pin 16) is input to VREF level or GND level by internal high accurate reference voltage. The CELLS pin (pin 11) can set the series battery number when the pin is input VREF, OPEN or GND level.

The setting of ADJ3 pin (pin 16), CELLS pin (pin 11) and charge voltage (DC/DC output) is shown below.

ADJ3 Input Voltage	CELLS	Charge Voltage	Note
VREF pin (ADJ3 ≥4.6 V)	OPEN	8.4 V	2 Cell × 4.20 V/Cell
	GND	12.6 V	3 Cell × 4.20 V/Cell
	VREF	16.8 V	4 Cell × 4.20 V/Cell
GND pin (ADJ3 ≤ 0.2 V)	OPEN	8.2 V	2 Cell × 4.10 V/Cell
	GND	12.3 V	3 Cell × 4.10 V/Cell
	VREF	16.4 V	4 Cell × 4.10 V/Cell
External voltage setting (ADJ3 = 0.4 V to 4.4 V)	OPEN	4 × ADJ3 pin voltage	2 Cell × 2 × ADJ3 pin voltage/Cell
	GND	6 × ADJ3 pin voltage	3 Cell × 2 × ADJ3 pin voltage/Cell
	VREF	8 × ADJ3 pin voltage	4 Cell × 2 × ADJ3 pin voltage/Cell

- ADJ3 Pin Internal Circuit



8.2.5 Setting the Charge Current

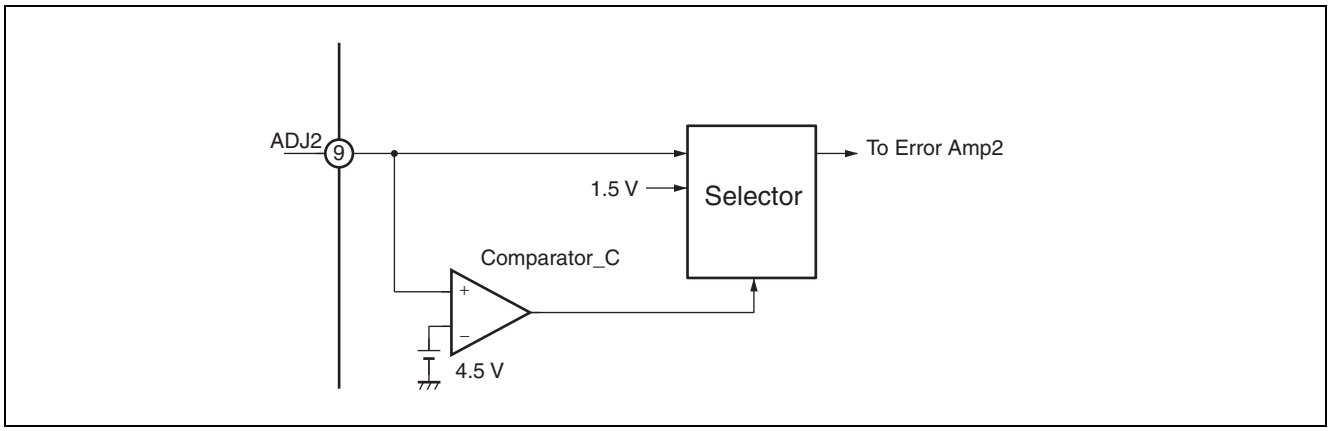
The Error amplifier block (Error Amp2) compares the output voltage of charge current control block set by ADJ2 pin (pin 9) with the output signal from the current detection amplifier (current Amp2) , and outputs a PWM control signal to be used in controlling the maximum charge current for battery. When the current overflows the rated value, the current will be constantly charged to the rated value, and the charge voltage will drop.

Battery charge current setting voltage : ADJ2

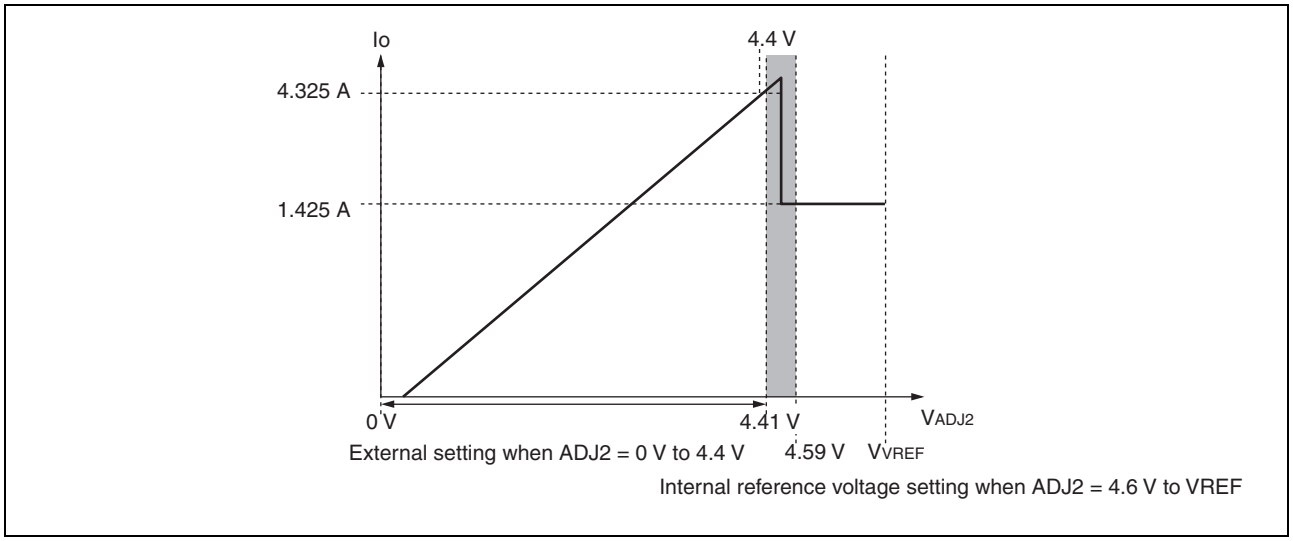
$$\text{Upper limit of charge current Io} = \frac{\text{Charge current control block output voltage (V)} - 0.075}{\text{Current detection amplifier block voltage gain (25.0 V/V Typ)} \times \text{sense resistor } R_S\ (\Omega)}$$

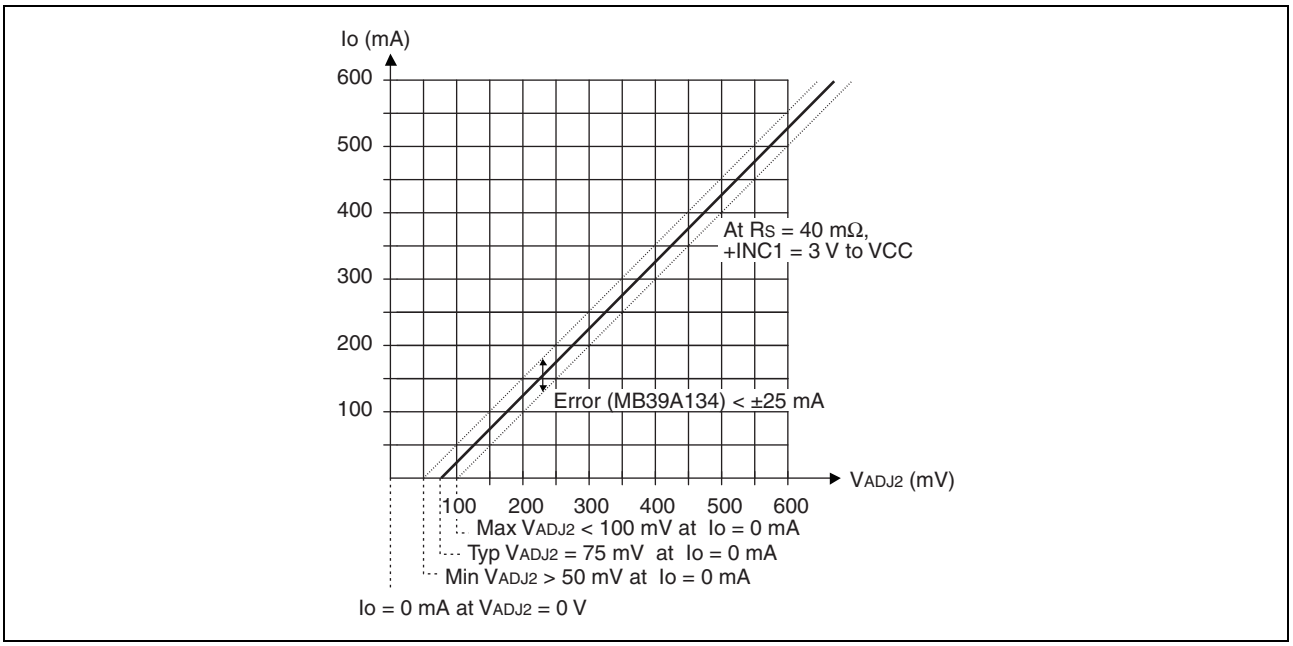
ADJ2 Input Voltage	Charge Current Control Block Output Voltage	Charge Current		
		$R_S = 40\ m\Omega$	$R_S = 20\ m\Omega$	$R_S = 15\ m\Omega$
VREF (ADJ2 > 4.6 V)	1.5 V	1.425 A	2.85 A	3.79 A
External Voltage Setting (ADJ2 = GND to 4.4 V)	V_{ADJ2} (V)	V_{ADJ2}-0.075 (A)	2 × (V_{ADJ2}-0.075) (A)	2.66 × (V_{ADJ2}-0.075) (A)

- ADJ2 Pin Internal Circuit



- Example of charge current setting (R_S = 40 mΩ)





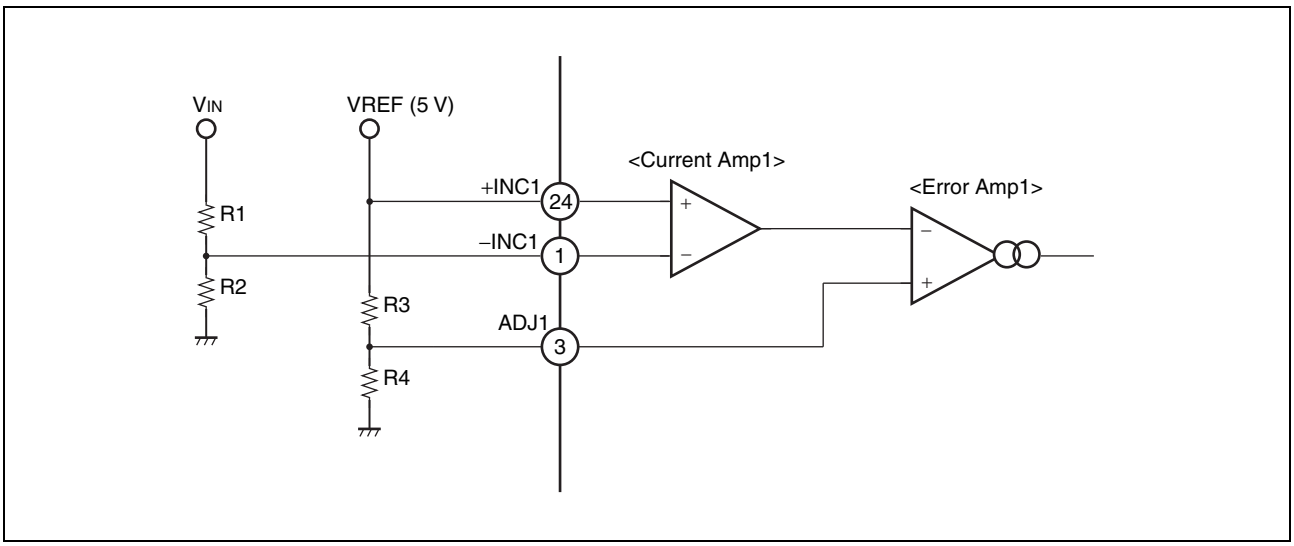
8.2.6 Setting Dynamically-Controlled-Charging

By connecting as shown in the example of the figure below, the AC adopter voltage (V_{IN}) drops and becomes the calculated Vth, and then, the dynamically-controlled charging loop reduce the charge current to keep a settled power level.

AC adopter voltage in dynamically controlled charging mode:

$$Vth = VREF \times \left(1 - \frac{1}{A_V} \times \frac{R4}{R3 + R4}\right) \times \frac{R1 + R2}{R2}$$

VREF : Reference voltage (5.0 V Typ) A_V : Current detection amplifier block voltage gain (25.0 V/V Typ)



9. Transit Response When a Load Changes Suddenly

The constant voltage control loop and the constant current control loop are independent each other and when a load changes suddenly, these two control loops switch over each other.

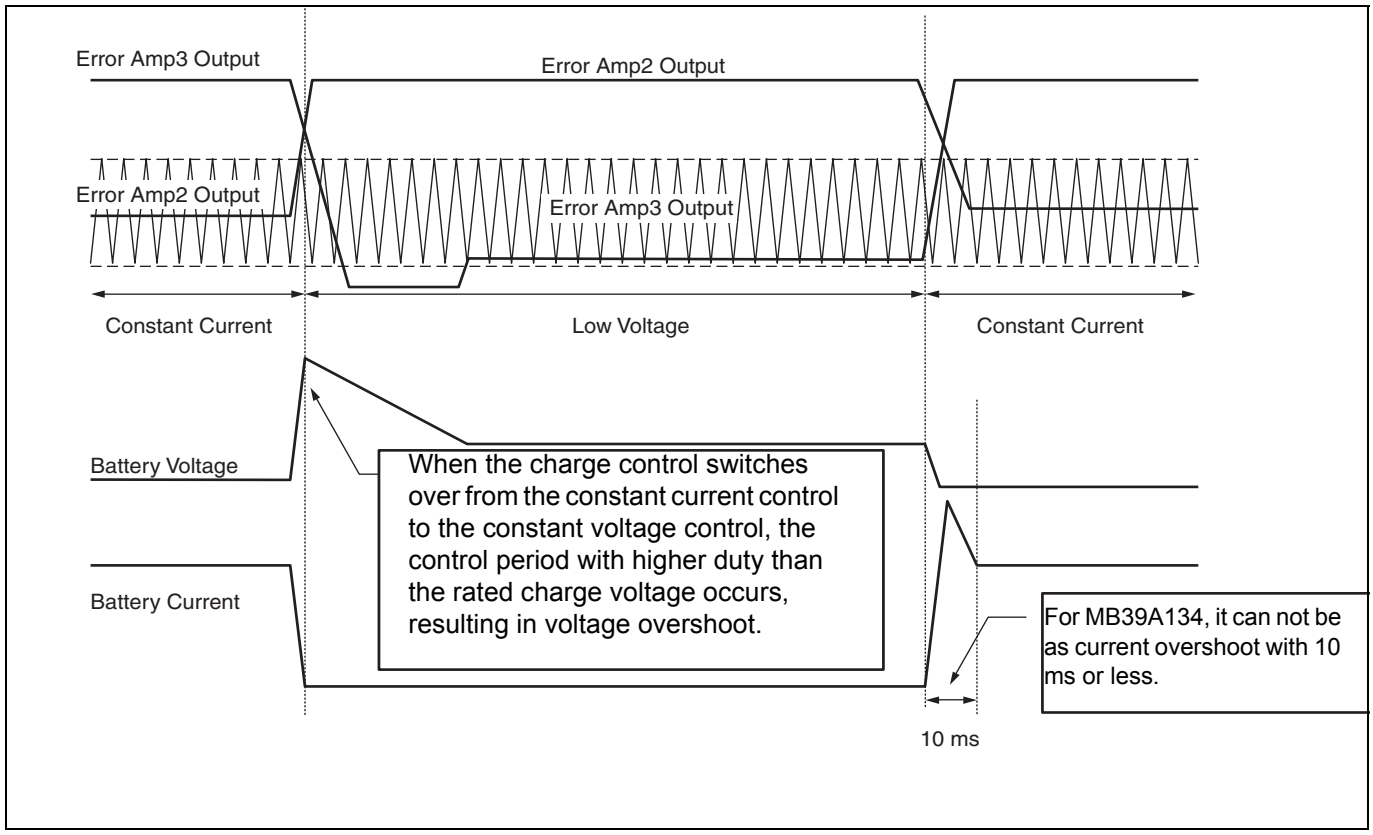
Overshoot of the battery voltage and current is generated by the delay in the control loop when changing the mode.

The delay time is determined by the phase compensation components values.

When the constant current control switches over to the constant voltage control when removing the battery, the control period with higher duty than the rated charge voltage occurs, resulting in voltage overshoot. In such a period, since the battery is removed, no excessive voltage should be applied to the battery.

When the constant voltage control switches over to the constant current control when installing the battery, the control period with higher duty than the rated charge current occurs, resulting in current overshoot.

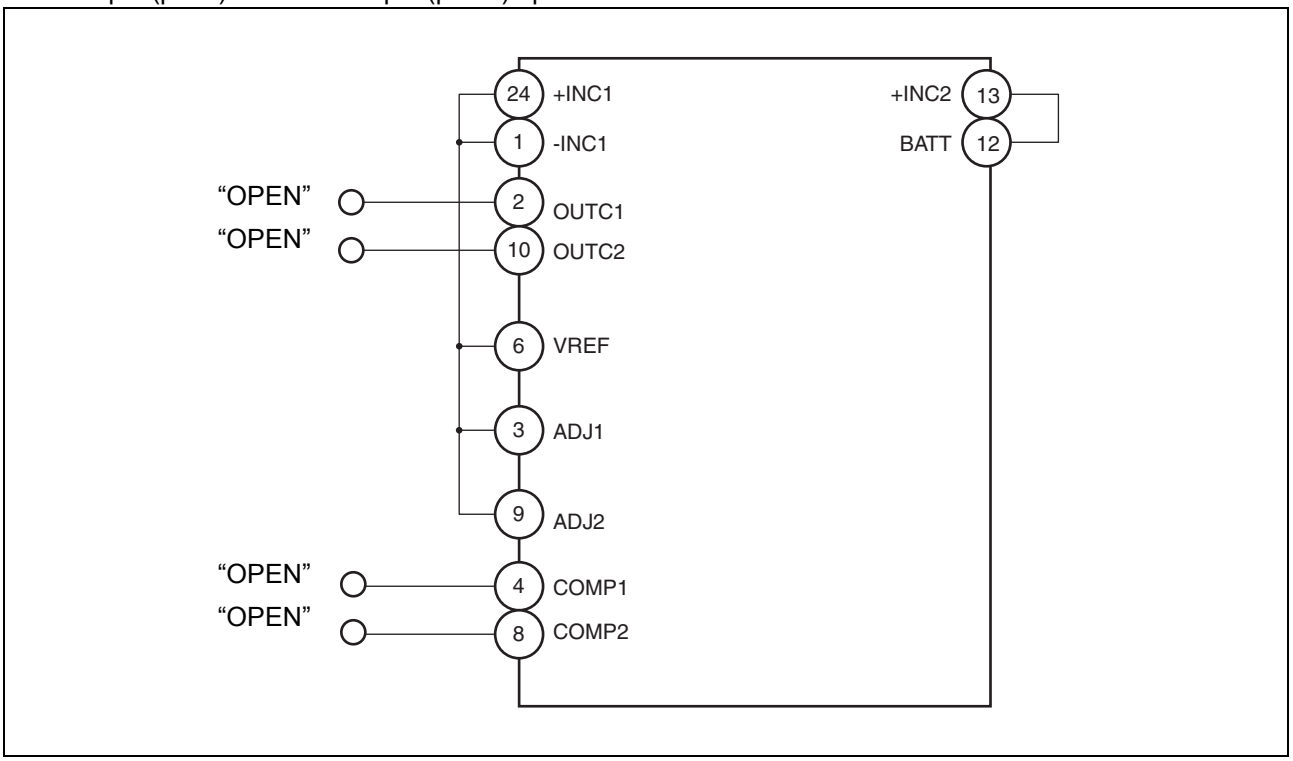
For MB39A134, it can not be as current overshoot with 10 ms or less.



10. Connection Without Using The Current Amp1, Current Amp2 and The Error Amp1, Error Amp2

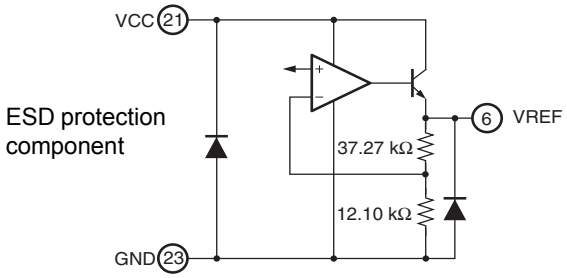
When Current Amp1, 2 or Error Amp1, 2 are not used, please connect it as follows.

- +INC1 pin (pin 24), -INC1 pin (pin 1), ADJ1 pin (pin 3), and ADJ2 pin (pin 9) are connected with the VREF pin.
- +INC2 pin (pin 13) is connected with the pin BATT pin (pin 12).
- OUTC1 pin (pin 2) and OUTC2 pin (pin10) open.

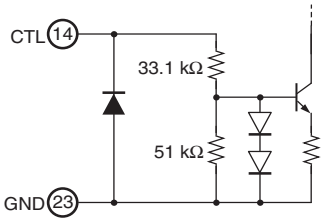


11. Input/Output Pin Equivalent Circuit Diagram

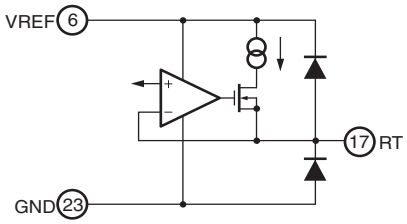
<Reference voltage block>



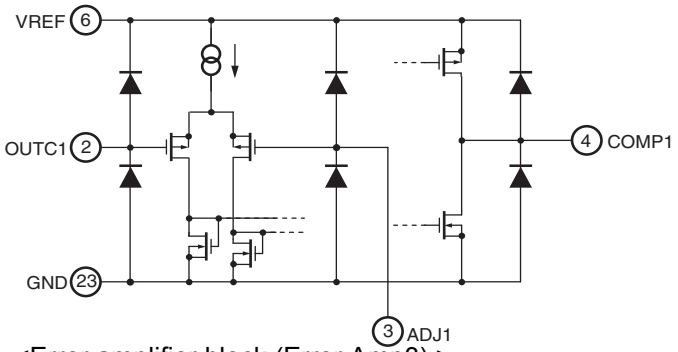
<Control bloc>



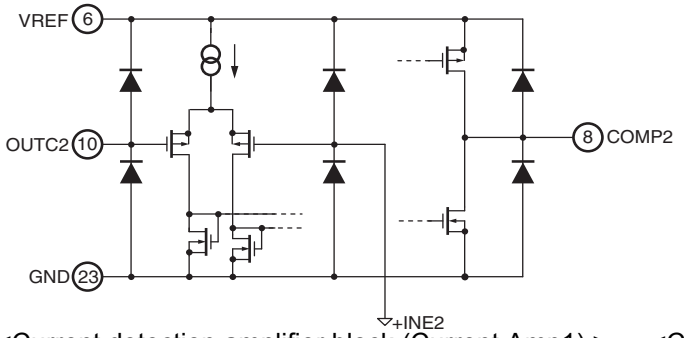
<Triangular wave oscillator block>



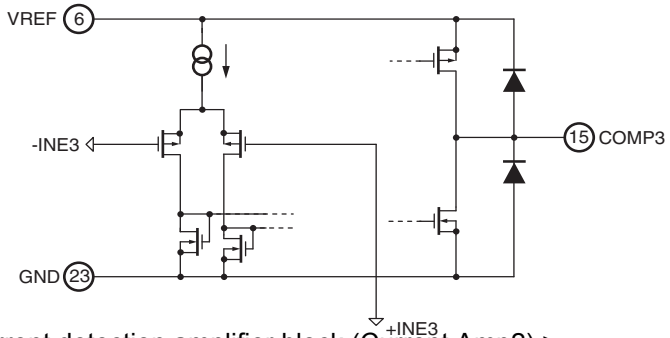
<Error amplifier block (Error Amp1) >



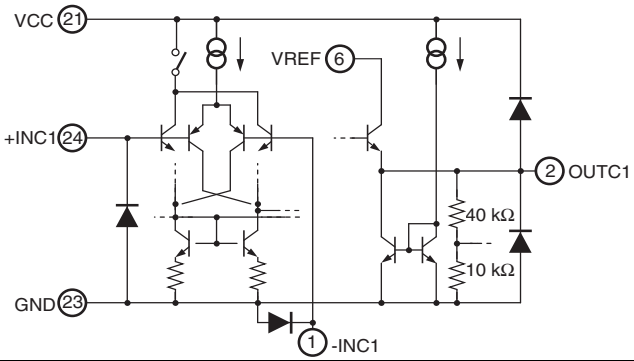
<Error amplifier block (Error Amp2) >



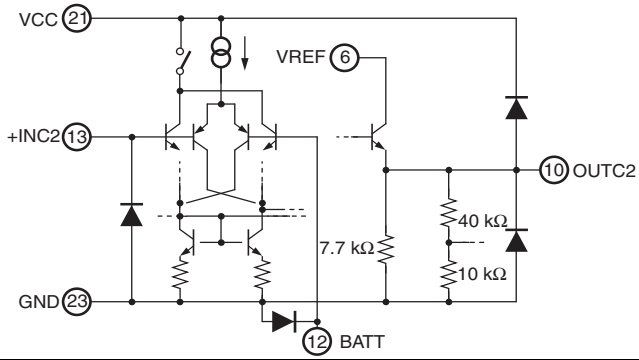
<Error amplifier block (Error Amp3) >



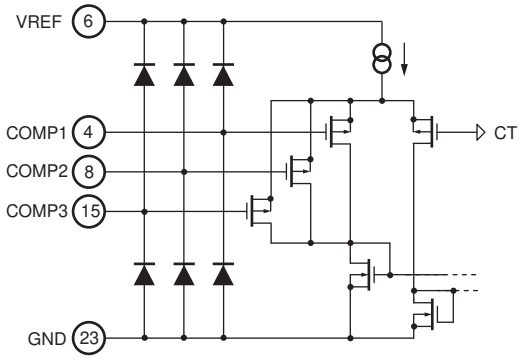
<Current detection amplifier block (Current Amp1) >



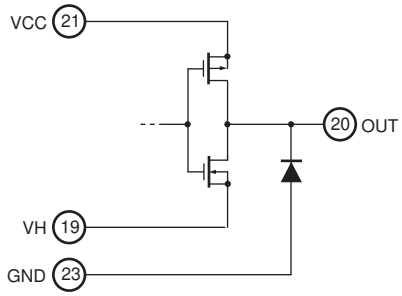
<Current detection amplifier block (Current Amp2) >



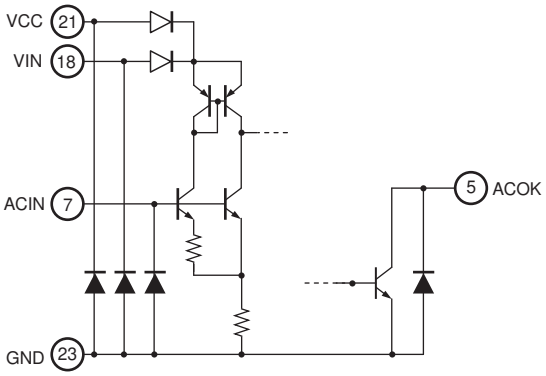
<PWM comparator block>



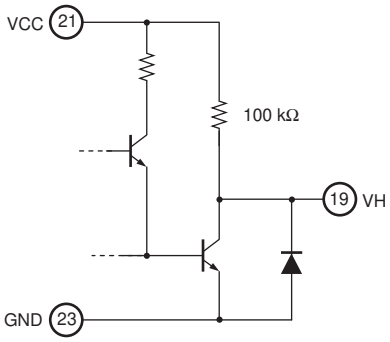
<Output block>



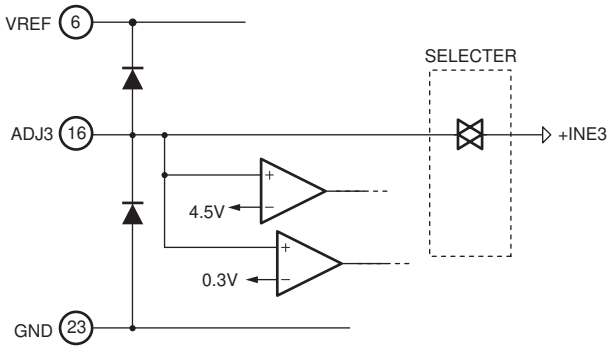
<AC adapter detection block>



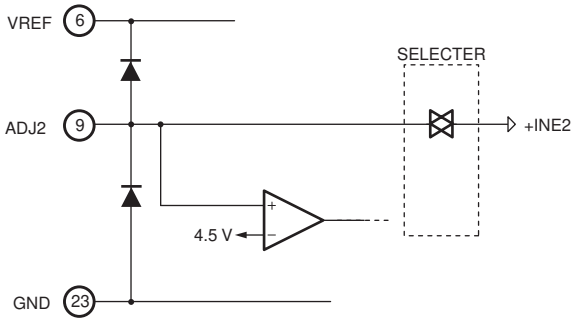
<Bias voltage block>



<Charge voltage setting block>



<Charge current setting block>



<Cell switch block>